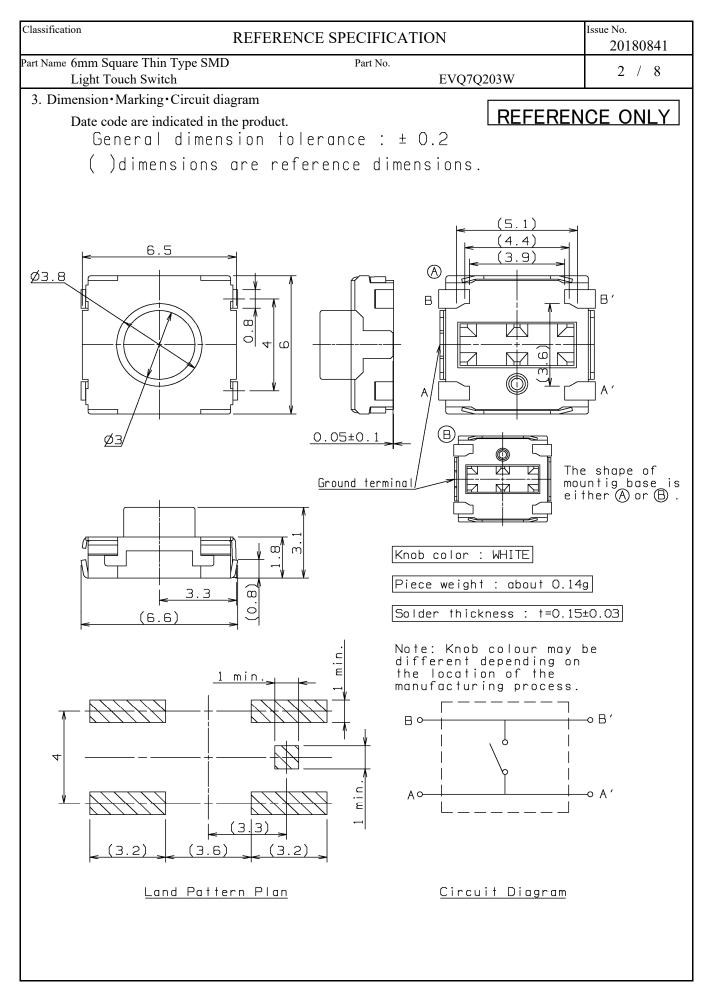
REFERENCE SPECIFICATION	20180841
Part Name 6mm Square Thin Type SMD Part No.	1 / 8
Light Touch Switch EVQ7Q203W	1 / 0
1. Notification Items	
1.1 Law and the regulation which are applied	
① Ozone depleting substances specified by Montreal Protocol have not been used in the manufacturing	
process of the material used in this product.	
② This product complies with RoHS Directive (on the restriction of the use of certain hazardous substant in electrical and electronic equipment) (2011/65/EU).	ices
<ul> <li>③ The materials used in this product contain only the substances listed in the List of Existing Chemical</li> </ul>	Substances
specified in 'Act on the Evaluation of Chemical Substances and Regulation of Their Manufacture, etc	
<ul> <li>④ Permission must be obtained from the Japanese government if the product that is subject to the</li> </ul>	•
"Foreign Exchange and Foreign Trade Law" is to be exported or taken out of Japan.	
1.2 Application Limits	
The following shall be described for safety precaution:	
[Limitation of Application]	
(a) This product has been designed and manufactured for general electronic devices,	
such as home electronics, office equipment, information devices and communication devices.	
(1) This product is not intended for use in more sophisticated applications which require a high	er safety standard
and more reliability, including if a failure or malfunction may cause bodily injury or proper	ty damage.
(2) If the product is intended for more sophisticated applications prior approval must be obtain	ied.
Such applications shall include, but are not limited to, the following: aircraft equipment,	
aerospace equipment, disaster prevention equipment, crime prevention equipment, medical	
transportation equipment (such as vehicles, trains, ships, etc.), and information processi	ng equipment
that are highly publicized, and other equivalent equipment.	1 6 4
(b) Regardless of its applications, in an event that this product is used for equipment with hig standards, protective circuits or back up circuits must be used and safety tests must be pe	•
standards, protective circuits of back up circuits must be used and safety tests must be pe	fiormeu.
1.3 Handling of reference specification.	
• Since the contents of this reference specification are subjected to change without	
prior notifications, please request us a formal specification again for your investigations	
before using.	
1.4 Manufacturing Sites	
The country of manufacture : Malaysia Panasonic Industrial Devices Malaysia Sdn. Bhd.	
<ol> <li>Summary</li> <li>This specifications applies to the following types of switch.</li> </ol>	
Push-ON type S.P.S.T	
2.2 This specifications is a constituent document of contract for business concluded between	
your company and Panasonic Corporation.	
2.3 Items not particularly specified in this specifications shall be in conformance with JIS Standards.	



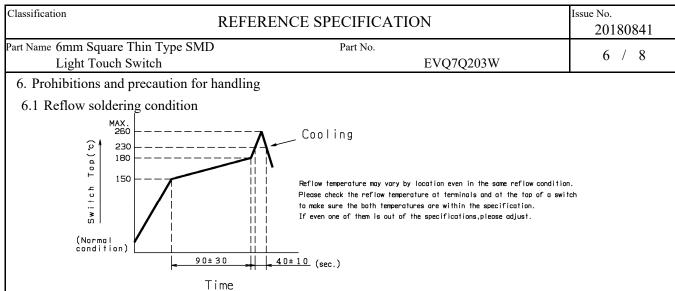
Panasonic Corporation

Classification	REFERENCE SPECIFICATION	Issue No. 20180841
Part Name 6mm Square Thin Type SMD Light Touch Switch	Part No. EVQ7Q20	3W 3 / 8
4. General specification		
4.1 Switch rating	DC 15 V 20 mA(max.) DC	2 V 10 μA(min.)
4.2 Operation temperature range	-40 $\sim$ + 85 $^{\circ}\mathrm{C}$	
4.3 Preservative temperature rang	ge Single condition : - 40 $\sim$ + 8	5 °C
	Taping condition : - 20 $\sim$ + 6	0 °C
4.4 Standard conditions		
Unless otherwise specifie	d, the test and measurements shall be carried ou	t as follows.
Ambient tempera	ature : 5 $\sim$ 35 $^{\circ}\mathrm{C}$	
Relative humidity	y : 45 $\sim$ 85 %	
Atmospheric pres	ssure : 86 $\sim$ 106 kPa	
However, if doubt arises of	on the decision based on the measured values	
under the above-mentione	ed conditions, the following conditions shall be	employed.
Ambient tempera	ature : $20 \pm 2 $ °C	
Relative humidity	y : 65 ± 5 %	
Atmospheric pres	ssure : 86 $\sim$ 106 kPa	
5. Performance		
5.1 Electrical characteristics		
No. ITEM	TEST CONDITION	PERFORMANCE
5.1.1 Contract Duck for	$(On a matrix for a) \times 2$	100 mO mov

No.	ITEM	TEST CONDITION	PERFORMANCE
5.1.1	Contact	Push force : {Operation force} $\times 2$	100 m $\Omega$ max.
	resistance	Measurement tool : Contact resistance meter	
		(Capable of 10 $\mu$ A $\sim$ 10 mA)	
5.1.2	Insulation	DC 100 V (Between terminals)	100 MΩ min.
	resistance		
5.1.3	Withstand	AC 250 V for 1 minute. (Between terminals)	No insulation
	voltage		destruction
5.1.4	Bouncing	Operation speed : $3 \sim 4$ times/s	ON
		D. C. 10V	10 ms max.
			OFF
		1mA Oscillo scope	10 ms max.
		Switch Bouncing Test Circuit	

ssification	1	<b>REFERENCE SPECIFICATION</b>		Issue No. 20180841
	mm Square Thin Ty ight Touch Switch	pe SMD Part No. EVQ7Q203W		4 / 8
5.2 Me	chanical characteri	stics		
No.	ITEM	TEST CONDITION	PERFORMANCE	
5.2.1	Operation force	Push force Return force Stroke	Push force $0.8 \stackrel{+}{} \stackrel{0.25}{} N$ Return force 0.1 N min	
5.2.2	Travel to closure	Stroke	0.2	2 <sup>+</sup> 0.1 mm
5.2.3	Push strength	50 N for 60 sec. $\mathbf{F}$	No damag (Electric	-
5.2.4	Vibration test	<ol> <li>Amplitude : 1.5 mm</li> <li>Sweep rate : 10-55-10Hz for 1 minute</li> <li>Sweep method : Logarithmic frequency sweep rate</li> <li>Vibration direction : X,Y,Z(3 directions)</li> <li>Time : Each direction 2 hours (Total 6 hours)</li> </ol>	No.5.1 an 5.2.1 to 5 be satisfie	.2.2 shall
5.2.5	Soldering heat test	<ul><li>Mount the switch on P.W.B by solder paste.</li><li>1) Reflow process 2 times. (Refer to section 6.1)</li><li>2) Standard conditions after test : 1 hours</li></ul>	No.5.2.1 shall be sa	nax. to 5.1.4 and to 5.2.2 atisfied.
5.2.6	Solderbility	After spreading flux, the terminal is immersed         in solder with following condition.         Solder bar       : M705/Sn-3.0Ag-0.5Cu         (Senju Metal Industry Co.,Ltd.)         Flux       : CF-110VH-2A (tamura kaken)         Soldering temperture       : 260±5°C         Soldering time       : 2±0.5 sec.	area(Excl surface)w immersed	

Classificatior	1	REFERENCE SPECIFICATION		Issue No. 20180841
	mm Square Thin Typ ight Touch Switch	Part No. EVQ7Q203W		5 / 8
5.3 Clin	natic characteristics	5		
No.	ITEM	TEST CONDITION	PERFORMANCE	
5.3.1	Cold test	1) Temperature : $-40\pm2$ °C	Contact r	esistance
		2) Duration of test : 500h	200 mΩ r	nax.
		3) Take off a drop water.	No.5.1.2	to 5.1.4 and
		4) Standard conditions after test : 1 h	No.5.2.1	to 5.2.2
			shall be s	atisfied.
5.3.2	Heat test	1) Temperature : $85\pm2$ °C	Contact r	esistance
		2) Duration of test : 500h	200 mΩ r	nax.
		3) Standard conditions after test : 1 h	No.5.1.2	to 5.1.4 and
			No.5.2.1	to 5.2.2
			shall be s	atisfied.
5.3.3	Heat shock	1) Test cycles : 20 cycles	Contact r	esistance
	test	2) Standard conditions after test : 1 h	200 mΩ r	nax.
		A:+85±2 °C	No.5.1.2	to 5.1.4 and
		B:-40±2 ℃	No.5.2.1	to 5.2.2
		B C:1 hour	shall be s	atisfied.
		C D E F D:5 minutes max. 1 cycle E:1 hour		
		F:5 minutes max.		
5.3.4	Humidity test	1) Temperature : $60\pm2$ °C	Contact r	esistance
		2) Relative humidity : $90 \sim 95 \%$	200 mΩ r	nax.
		3) Duration of test : 500 h	No.5.1.2	to 5.1.4 and
		4) Take off a drop water.	No.5.2.1	to 5.2.2
		5) Standard conditions after test : 1 h	shall be s	atisfied.
5.3.5	Endurance	1) DC 15 V 20 mA Resistance load	Contact r	esistance
	(Switching	2) Operation speed : $2 \sim 3$ times/s	20	$\Omega$ max.
	action)	3) Push force : Maximum value of operation	Bouncing	g : 10 ms max.
		force	Variation	rate of
		4) Operation number : 2,000,000 times	operation	force shall
			be within	$\pm 30$ % to the
			value bef	ore testing
			No.5.1.2	and 5.2.2
			shall be sa	tisfied.
5.3.6	Withstand H <sub>2</sub> S	1) Density : 3±1ppm	Contact r	esistance
	2	2) Temperature : $40\pm2$ °C	200 mΩ r	nax.
		3) Relative humidity : $80 \sim 85\%$	No.5.1.2	to 5.1.4 and
		4) Duration of test : 24 h	No.5.2.1	to 5.2.2
		5) Standard conditions after test : 1 h	shall be s	atisfied.
			•	



- 1) Two times max. with directing the switch mounting side of P.W.B up.
- 2) Re-soldering by soldering iron shall be allowed under 350 °C max. 3 sec. max. 1 time only and the tip of iron must not touch to terminals.

Soldering iron for re-soldering have to be 60 W max.

- 6.2 Design instructions
  - 1) Please refer to the land pattern plan Panasonic recommends on the 2nd page.
  - 2) Design key top as fig-1. Design inclination of key top 4 deg. max. as fig-2.Deviation between center of key top and switch should be within 0.3 mm. (Recommended operation condition)

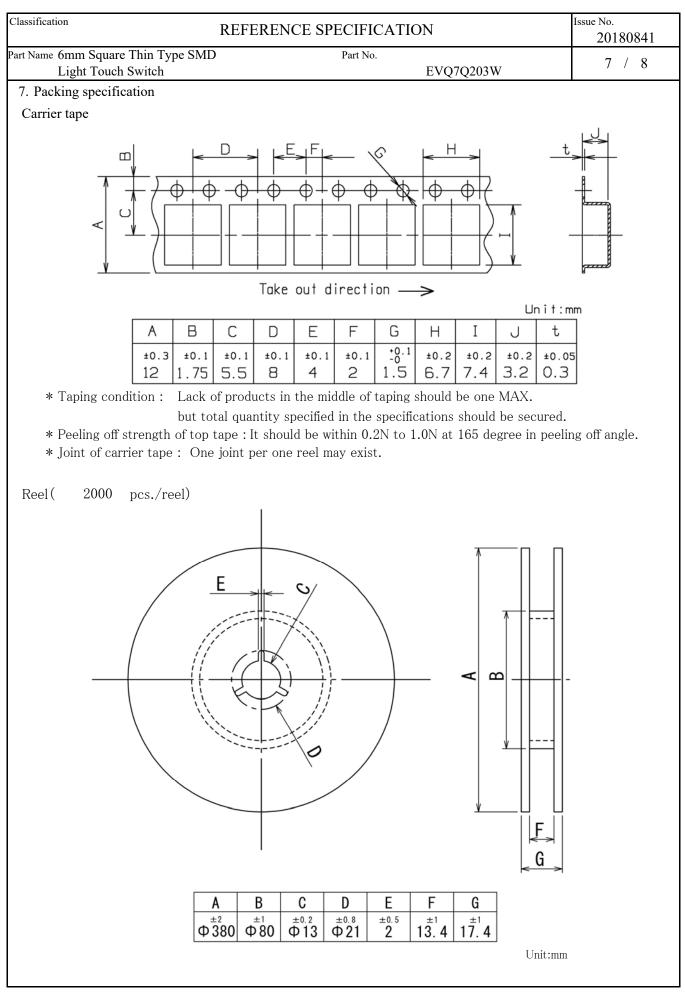


## 6.3 Note

- 1) Please be cautions not to give excessive static load or shock to switches.
- 2) Please be careful not to pile up P.W.B. after switches were soldered.
- Preservation under high temperature and high humidity or corrosive gas should be avoided especially. When you need to preserve for a long period, do not open the carton.
- 4) Cleaning
  - If flux or solder is scattered on the surface of P.W.B when soldering, characteristics of this product may be damaged.
  - Cleaning after soldering is not allowed. When cleaning is required this switch should be soldered after the cleaning.
- 5) Avoid the use of the switch under pushed ON condition is continued for a long time.
- 6) There is a possibility the flux from solder paste infiltrates into the body if plenty of solder paste was applied by switch on the P.W.B.

So we recommend to use our proposed land design in order to prevent above problem.

Also please avoid putting additional land by the switch on the P.W.B.



Panasonic Corporation

Classification REFERE	NCE SPECIFICATION	Issue No. 20180841
Part Name 6mm Square Thin Type SMD	Part No.	8 / 8
Light Touch Switch <prohibitions and="" for="" handling="" precaution=""></prohibitions>	EVQ7Q203W	
[Prohibited items on fire and smoking]		
•	nd its rated range because doing so may cause a fi	re
	nder conditions in which the product is used out of	
	as current interruption using a protective circuit.	i its
	used in product is "94HB, " which is based on UL	04
· ·	materials). Prohibit use in a location where a	2 <b>2</b> 7
spreading fire may be generated or prep		
spreading fire may be generated of prep	are against a spreading me.	
[For use in equipment for which safety is re	equested	
• Although care is taken to ensure produce	et quality, inferior characteristics, short circuits,	
and open circuits are some problems the	at might be generated. To design an equipment wh	nich
places maximum emphasis on safety, re	eview the effect of any single fault of a product	
in advance and perform virtually fail-sa	fe design to ensure maximum safety by:	
• Preparing a protective circuit or a p	protective device to improve system safety, and eq	uipment.
• Preparing a redundant circuit to imp	prove system safety so that the single fault	
of a product does not cause a dange	erous situation.	
[Attentions required for stores and dision]		
[Attentions required for storage condition]	following airgumstances and conditions, it may	
-	following circumstances and conditions, it may s and solderability etc., avoid storing in the	
following conditions.	s and solderability etc., avoid storing in the	
C C	-10°C max., +40°C min. and the humidity is 85%	min.
(2) In the corrosive gas atmosphere.		
(3) Long-term storage for 6 months	min.	
(4) A place where the product is exp		
• Store in packed condition so that the lo	-	
-	ble, our recommendation is within 3 months and t	he
limitation is 6 months.		
• If any remainder left after packing is op	bened, store it with proper moistureproofing and	
gasproofing, etc.,		